





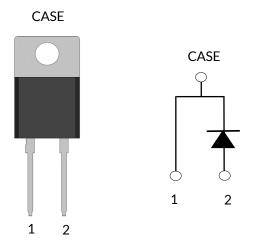








UJ3D1205TS



Silicon Carbide (SiC) Diode - EliteSiC, TO-220-2L, 5 A, 1200 V SiC Merged PiN-Schottky (MPS) Diode

Rev. D, Jan 2025

Description

UnitedSiC offers the 3^{rd} generation of high performance SiC Merged-PiN-Schottky (MPS) diodes. With zero reverse recovery charge and 175° C maximum junction temperature, these diodes are ideally suited for high frequency and high efficiency power systems with minimum cooling requirements.

Features

- Maximum operating temperature of 175°C
- Easy paralleling
- Extremely fast switching not dependent on temperature
- No reverse or forward recovery
- Enhanced surge current capability, MPS structure
- Excellent thermal performance, Ag sintered
- 100% UIS tested

Part Number	Package	Marking
UJ3D1205TS	TO-220-2L	UJ3D1205TS











Typical applications

- Power converters
- Industrial motor drives
- Switch mode power supplies
- Power factor correction modules













Maximum Ratings

Parameter	Symbol	Test Conditions	Value	Units	
DC blocking voltage	V_R		1200	V	
Repetitive peak reverse voltage, T _J =25°C	V_{RRM}		1200	V	
Surge peak reverse voltage	V_{RSM}		1200	V	
Maximum DC forward current	I _F	$T_{C} = 160.7^{\circ}C$	5	Α	
Non-repetitive forward surge current	1	$T_C = 25$ °C, $t_p = 10$ ms	70	Α	
sine halfwave	I _{FSM}	$T_C = 110^{\circ}C, t_p = 10 \text{ms}$	63		
Repetitive forward surge current	1	$T_C = 25$ °C, $t_p = 10$ ms	31.8	Α	
sine halfwave, D=0.1	I _{FRM}	$T_C = 110^{\circ}C, t_p = 10 \text{ms}$	18.6		
Non-repetitive peak forward current		$T_C = 25^{\circ}C, t_p = 10 \mu s$	525		
	I _{F,max}	$T_C = 110^{\circ}C, t_p = 10\mu s$	525	Α	
-2.	∫i²dt	$T_C = 25$ °C, $t_p = 10$ ms	24.5	A^2s	
i ² t value		$T_C = 110^{\circ}C, t_p = 10 \text{ms}$	19.5	A S	
Power dissipation	P _{tot}	T _C = 25°C	136	14/	
		T _C = 160.7°C	13	W	
Maximum junction temperature	$T_{J,max}$		175	°C	
Operating and storage temperature	T_J,T_STG		-55 to 175	°C	
Soldering temperatures, wavesoldering only allowed at leads	T _{sold}	1.6mm from case for 10s	260	°C	

Thermal Characteristics

Parameter	Symbol	Test Conditions	Value			- Units
			Min	Тур	Max	Offics
Thermal resistance, junction-to-case	$R_{ heta$ JC			0.85	1.1	°C/W

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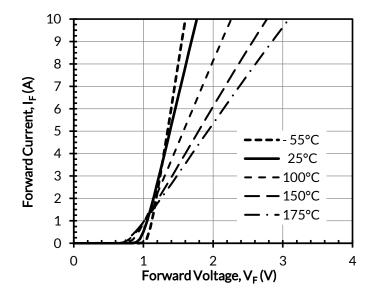


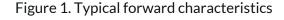
Electrical Characteristics (T_J = +25°C unless otherwise specified)

Parameter	Symbol	Test Conditions	Value			Units
			Min	Тур	Max	Units
Forward voltage	V _F	$I_F = 5A, T_J = 25^{\circ}C$	-	1.4	1.6	V
		I _F = 5A, T _J =150°C	-	1.85	2.3	
		I _F = 5A, T _J =175°C	-	2	2.6	
Reverse current	I _R	V _R =1200V, T _J =25°C	-	5	55	μΑ
		V _R =1200V, T _J =175°C	-	160		
Total capacitive charge ⁽¹⁾	Q _C	V _R =800V		27		nC
Total capacitance	С	$V_R=1V, f=1MHz$		250		pF
		V _R =400V, f = 1MHz		24.5		
		V _R =800V, f = 1MHz		22		
Capacitance stored energy	E _C	V _R =800V		8		μЈ

(1) Q_c is independent on T_J , di_F/dt , and I_F as shown in the application note USCi_AN0011.

Typical Performance Diagrams





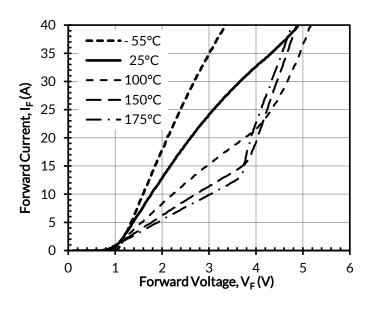


Figure 2. Typical forward characteristics in surge current

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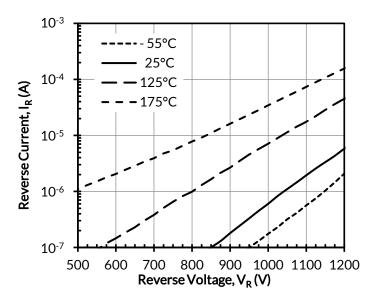








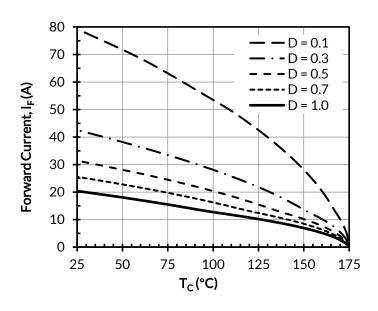




150
125
100
125
100
25
50
25
100
125
150
175
T_c(°C)

Figure 3. Typical reverse characteristics

Figure 4. Power dissipation



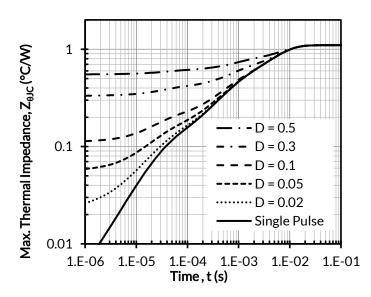


Figure 5. Diode forward current

Figure 6. Maximum transient thermal impedance



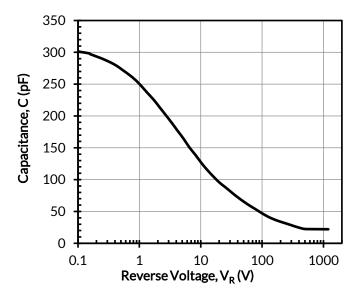












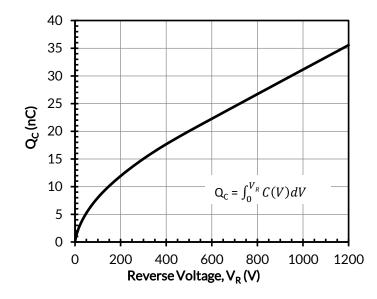


Figure 7. Capacitance vs. reverse voltage at 1MHz

Figure 8. Typical capacitive charge vs. reverse voltage

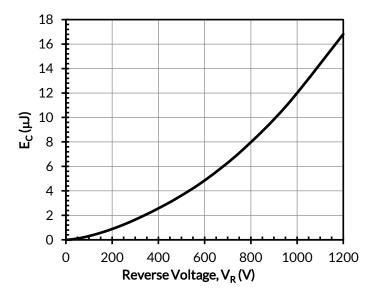


Figure 9. Typical capacitance stored energy vs. reverse voltage













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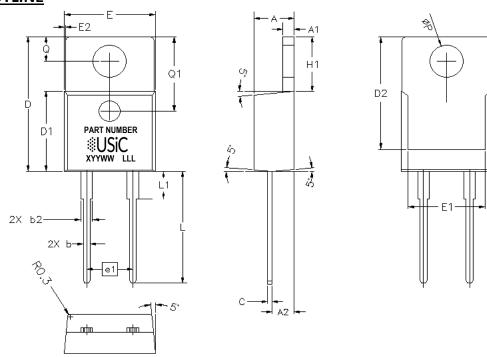
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TO-220-2L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

PACKAGE OUTLINE

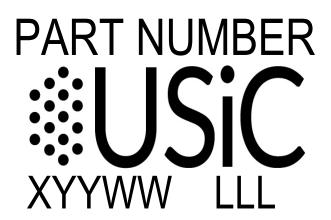


DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
Α	0.140	0.190	3.56	4.83
A1	0.020	0.055	0.51	1.40
A2	0.080	0.115	2.03	2.92
b	0.015	0.040	0.38	1.02
b2	0.040	0.070	1.02	1.78
С	0.014	0.030	0.36	0.76
D	0.560	0.650	14.22	16.51
D1	0.330	0.370	8.38	9.40
D2	0.480	0.517	12.19	13.13
Е	0.380	0.420	9.65	10.67
e1	0.200 BSC		5.08	BSC
E1	0.270	0.350	6.86	8.89
E2	-	0.030		0.76
L	0.495	0.580	12.57	14.73
L1	-	0.250	1	6.35
ØΡ	0.139	0.161	3.53	4.09
Н	0.230	0.270	5.84	6.86
Q	0.100	0.135	2.54	3.43
Q1	0.330	0.340	8.38	8.64



TO-220-2L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

PART MARKING



PART NUMBER = REFER TO
DS PN DECODER FOR DETAILS

X = ASSEMBLY SITE

YY = YEAR

WW = WORK WEEK

LLL = LOT ID

PACKING TYPE

ANTI-STATIC TUBE

QUANTITY /TUBE: 50 UNITS

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